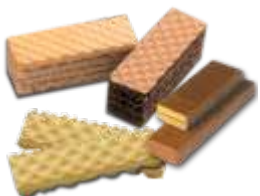


“ZWT” Series Wafer Biscuit Plants

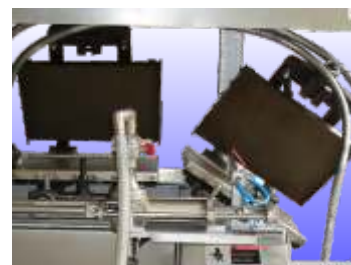
Size Of Baking Plate 270X370



ECONOMICAL ✦ EFFICIENT ✦ LOW FUEL CONSUMPTION ✦ FLEXIBLE ✦ UPGRADABLE

“ZWT” Wafer Baking Machine

The Automatic wafer Baking Machine ZWT Series is designed for fully automatic production of wafer sheets with fine, medium or deep reeding as well as hollow wafer sheets. It may be equipped with 12, 18, 24,30,36,42 baking tongs.



Heating System

The automatic baking machine is equipped with high efficiency triangular burners that can be adjusted for an extremely even application of heat over the entire surface of the baking plates.

HEATING (By Liquified Gas (LPG) / Natural Gas)

By Gas : The heating system has automatic ignition. In case of gas, air or power failure, an automatic cutout device on the heating system will operate.

Baking Plates

The plates are made of special alloy. The selection of alloy and the casting procedure ensures dimensional stability, a homogenous and dense surface, thermal stability, good heat accumulation characteristics and excellent thermal conductivity. Special finishing is done to ensure troublefree release of wafer sheets. The wafer thickness is quickly and easily adjusted by applying spacing shims.



Special Design



Regular Design

Technical Specifications

Size Of Baking Plates 270 X 370

ZWT AUTOMATIC WAFER BAKING M/C	ZWT12	ZWT18	ZWT24	ZWT30	ZWT36	ZWT42
Output of wafer sheets/Hr*	360	640	860	1080	1300	1500
Cream filled wafers/Hour (Kgs.approx.)	18-20	36-40	48-50	65-70	80-85	90-95
GAS HEATING: LP Gas Consumption/Hr	4-5	6-8	8-10	12-14	16-18	18-20
Electric Load (Kw)	3.5	3.5	3.5	3.5	3.5	3.5
DIMENSIONS (approx.)						
Length	3400	4600	5800	7000	8200	9400
Width	1100	1100	1100	1500	1500	1500
Height	2000	2000	2000	2000	2000	2000
Net Weight	1300	1900	2500	3100	3700	4300
Weight incl. Seaworthy packing	1800	2500	3250	3900	4600	5000
Shipping space in m ³	4.5	5.5	7.0	15.0	18.0	20.0

*Modifications Reserved

We are constantly guided by our principle of offering our customers better and better machines; to give increased efficiency and higher levels of automation. The technical data and illustrations are subject to change without notice

R&D Engineers

A-41, IDA Kukatpally, Phase II, Road No.4, Via I.E. Gandhi Nagar, Hyderabad-500 037. India.

Phone: 23079121, 23077985, Fax: 0091-40-23078668

E-mail: info@rndwafers.com [Web: www.rndwafers.com](http://www.rndwafers.com)

Local Contact :